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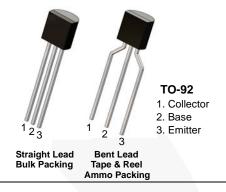


September 2015

BC337 / BC338 NPN Epitaxial Silicon Transistor

Features

- Switching and Amplifier Applications
- Suitable for AF-Driver Stages and Low-Power Output Stages
- · Complement to BC327 / BC328



Ordering Information

Part Number	Top Mark	Package	Packing Method	
BC33716BU	BC33716	TO-92 3L	Bulk	
BC33716TA	BC33716	TO-92 3L	Ammo	
BC33716TFR	BC33716	TO-92 3L	Tape and Reel	
BC33725BU	BC33725	TO-92 3L	Bulk	
BC33725TA	BC33725	TO-92 3L	Ammo	
BC33725TAR	BC33725	TO-92 3L	Ammo	
BC33725TF	BC33725	TO-92 3L	Tape and Reel	
BC33725TFR	BC33725	TO-92 3L	Tape and Reel	
BC33740BU	BC33740	TO-92 3L	Bulk	
BC33740TA	BC33740	TO-92 3L	Ammo	
BC33825TA	BC33825	TO-92 3L	Ammo	

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}\text{C}$ unless otherwise noted.

Symbol	Parameter		Value	Unit
V _{CES}	Collector Emitter Voltage	BC337	50	
	Collector-Emitter Voltage	BC338	30	V
V_{CEO}	Collector-Emitter Voltage	BC337	45	V
	Collector-Emitter voltage	BC338	25	v
V _{EBO}	Emitter-Base Voltage		5	V
I _C	Collector Current (DC)		800	mA
TJ	Junction Temperature		150	°C
T _{STG}	Storage Temperature		-55 to 150	°C

Thermal Characteristics(1)

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Value	Unit
D	Power Dissipation	625	mW
P _D	Derate Above 25°C	5.0	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	200	°C/W

Note:

1. PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

Electrical Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter		Conditions	Min.	Тур.	Max.	Unit
Collector-Emitter		BC337	I - 10 m	45			V
BV _{CEO}	Breakdown Voltage	BC338	$I_{\rm C} = 10 \text{ mA}, I_{\rm B} = 0$	25			V
D\/	Collector-Emitter		1 - 0.1 m/ \/ - 0	50			V
BV _{CES}	Breakdown Voltage	BC338	$I_{C} = 0.1 \text{ mA}, V_{BE} = 0$	30			V
BV _{EBO}	Emitter-Base Breakdown Volt	tage	$I_E = 0.1 \text{ mA}, I_C = 0$	5			V
1	Collector Cut-Off Current	BC337	$V_{CE} = 45 \text{ V}, I_{B} = 0$		2	100	nA
ICES		BC338	$V_{CE} = 25 \text{ V}, I_{B} = 0$		2	100	11/4
h _{FE1}	DC Current Gain		$V_{CE} = 1 \text{ V}, I_{C} = 100 \text{ mA}$	100		630	
h _{FE2}			$V_{CE} = 1 \text{ V, } I_{C} = 300 \text{ mA}$	60			
V _{CE} (sat)	t) Collector-Emitter Saturation Voltage		$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$			0.7	V
V _{BE} (on)	Base-Emitter On Voltage		$V_{CE} = 1 \text{ V, } I_{C} = 300 \text{ mA}$			1.2	V
f _T	Current Gain Bandwidth Product		$V_{CE} = 5 \text{ V}, I_{C} = 10 \text{ mA},$ f = 50 MHz		100		MHz
C _{ob}	Output Capacitance		V _{CB} = 10 V, I _E = 0, f = 1 MHz		12		pF

h_{FE} Classification

Classification	16	25	40
h _{FE1}	100 ~ 250	160 ~ 400	250 ~ 630
h _{FE2}	60 ~	100 ~	170 ~

Physical Dimensions

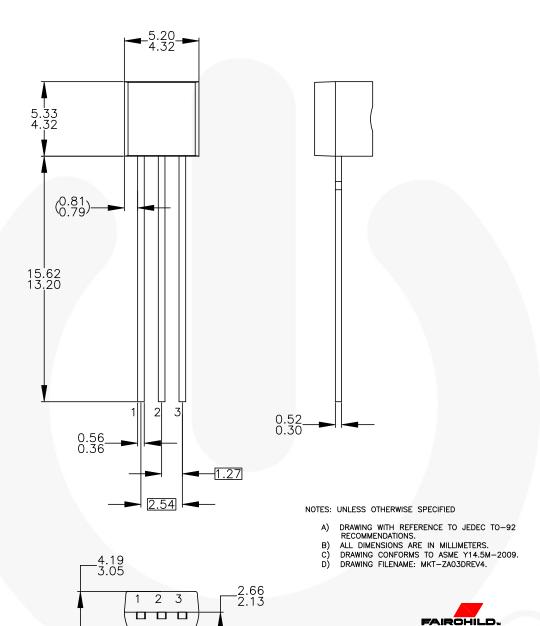
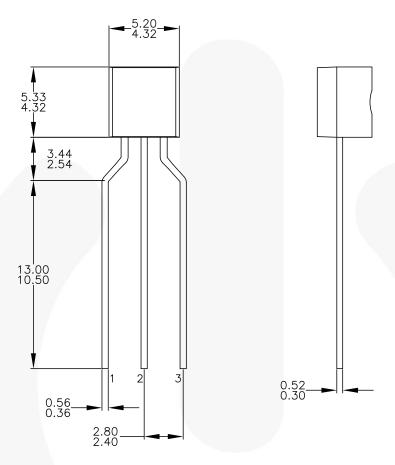
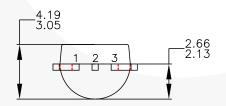


Figure 1. 3-Lead, TO-92, JEDEC TO-92 Compliant Straight Lead Configuration, Bulk Type

Physical Dimensions (Continued)





NOTES: UNLESS OTHERWISE SPECIFIED

- DRAWING CONFORMS TO JEDEC MS-013, VARIATION AC. ALL DIMENSIONS ARE IN MILLIMETERS. DRAWING CONFORMS TO ASME Y14.5M-2009. DRAWING FILENAME: MKT-ZAO3FREV3. FAIRCHILD SEMICONDUCTOR.

Figure 2. 3-Lead, TO-92, Molded, 0.2 In Line Spacing Lead Form, Ammo, Tape and Reel Type





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Definition of Terms

Definition of Terms				
Datasheet Identification	Product Status	Definition		
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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

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